

DATASHEET

XI3030P Color Series



Features

- Top view LED
- Wide viewing angle
- Pb-free
- · RoHS compliant

Description

The Everlight XI3030P package has high efficacy, mid power consumption, wide viewing angle and a compact form factor. These features make this package an ideal LED for all lighting applications.

Applications

- · Decorative and Entertainment Lighting
- · Agriculture Lighting
- · General use



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Max. DC Forward Current (mA)	I _F	200	mA
Thermal Resistance	R _{th}	15	°C/W
Max. Junction Temperature	T _J	125/115 _[1]	°C
Operating Temperature	T_{Opr}	-40 ~ +85	°C
Storage Temperature	T _{Stg}	-40 ~ +100	°C
Max. Soldering Temperature	T _{Sol}	260	°C
Max. Allowable Reflow Cycles	n/a	2	cycles

Notes:

1. For Far/Deep Red/Green/Amber/Orange/Red, the max. junction temperature=115°C. For Royal Blue, the max. junction temperature=125°C.



PN of the XI3030P Color Series LEDs

Color	Order Code of XI3030P Color Series	Minimum Luminous Flux (lm)	Typical Luminous Flux (lm)	Dominant Wavelength (nm)	Forward Voltage (V)	Current (mA)
Green	XI3030P/G3C-D1530M4PA28371Z15/2N	21	27	515-530	2.8-3.7	150
Amber	XI3030P/Y3C-D8095L6M317281Z15/2N	15	17	580-595	1.7-2.8	150
Orange	XI3030P/O3C-D0520L6M415281Z15/2N	15	18	605-620	1.5-2.8	150
Red	XI3030P/R3C-D1530L7N315281Z15/2N	16	19	615-630	1.5-2.8	150

Color	Order Code of XI3030P Color Series	Minimum Radiant Flux (mW)	Typical Radiant Flux (mW)	Dominant Wavelength (nm)	Forward Voltage (V)	Current (mA)
Royal Blue	XI3030P/B3C-D5060T2T625312Z15/2N	190	220	450-460	2.5-3.1	150

Color	Order Code of XI3030P Color Series	Minimum Radiant Flux (mW)	Typical Radiant Flux (mW)	Peak Wavelength (nm)	Forward Voltage (V)	Current (mA)
Deep Red	XI3030P/D3C-P4575S1S621271Z15/2N	100	137	645-675	2.1-2.7	150
Far Red	XI3030P/F3C-P1545R5S115251Z15/2N	70	83	715-745	1.4-2.5	150

- 1. Luminous /Radiant Flux measurement tolerance: ±10%.
- The data of luminous flux measured at thermal pad=25°C.
- Typical luminous flux or light output performance is operated within the condition guided by this datasheet.



Product Binning

Luminous Flux Bins

Bin Code	Minimum Luminous Flux (lm)	Maximum Luminous Flux (lm)
L5	14	15
L6	15	16
L7	16	17
L8	17	18
L9	18	19
M3	19	21
M4	21	24
N3	24	27
N4	27	33
P3	33	36
PA	36	40
PB	40	45

Radiant Flux Bins

Bin Code	Minimum Radiant Flux (mW)	Maximum Radiant Flux (mW)
R4	65	70
R5	70	76
R6	76	83
R7	83	90
R8	90	100
S1	100	110
S2	110	120
S3	120	130
S4	130	140
S5	140	150
S6	150	160
S7	160	170
S8	170	180
T1	180	190
T2	190	200
Т3	200	220
T4	220	240
T5	240	260
T6	260	280
T7	280	300

- Luminous / Radiant flux measurement tolerance: ±10%.
- Forward voltage bins are defined at I_F=150mA operation.



Dominant /Peak Wavelength Bins

Group	Bin	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
В	51	450	455
Ь	52	455	460
	51	515	520
G	52	520	525
	53	525	530
	51	580	585
Y	52	585	590
	53	590	595
	52	605	610
0	53	610	615
	54	615	620
R	51	620	625
, r	52	625	630

Group	Bin	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
	51	640	645
	52	645	650
	53	650	655
D	54	655	660
	55	660	665
	56	665	670
	57	670	675
	A2	710	720
F	A3	720	730
F	A4	730	740
	A5	740	750

- $1. \quad \text{Dominant/Peak Wavelength measurement tolerance: } \pm 1 \text{nm}.$
- 2. Forward voltage bins are defined at I_F =150mA operation.



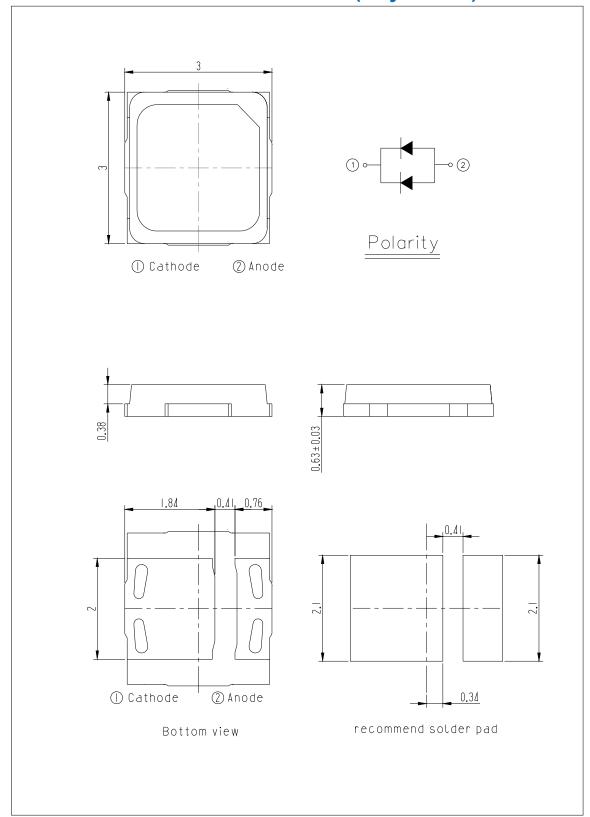
Forward Voltage Bins

Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
1415	1.4	1.5
1516	1.5	1.6
1617	1.6	1.7
1718	1.7	1.8
1819	1.8	1.9
1920	1.9	2.0
2021	2.0	2.1
2122	2.1	2.2
2223	2.2	2.3
2324	2.3	2.4
2425	2.4	2.5
2526	2.5	2.6
2627	2.6	2.7
2728	2.7	2.8
2829	2.8	2.9
2930	2.9	3.0
3031	3.0	3.1
3132	3.1	3.2
3233	3.2	3.3
3334	3.3	3.4
3435	3.4	3.5
3536	3.5	3.6
3637	3.6	3.7

- 1. Forward voltage measurement tolerance: ±2%.
- 2. Forward voltage bins are defined at I_F =150mA operation.



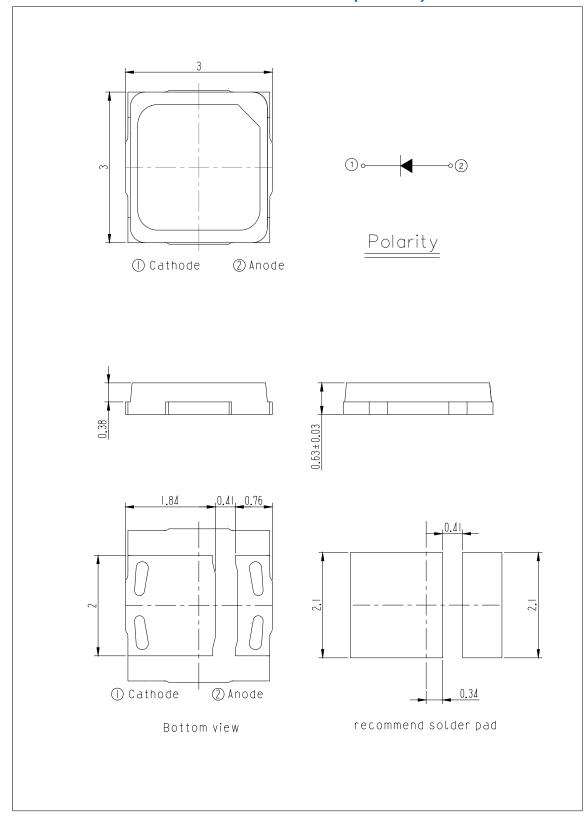
Mechanical Dimension (Royal Blue)



- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ± 0.2mm.
- 3. The thermal pad is electrically unity from the Cathode and contact pads.
- 4. Do not handle the device by the lens. Incorrect force applied to the lens may lead to the failure of devices.



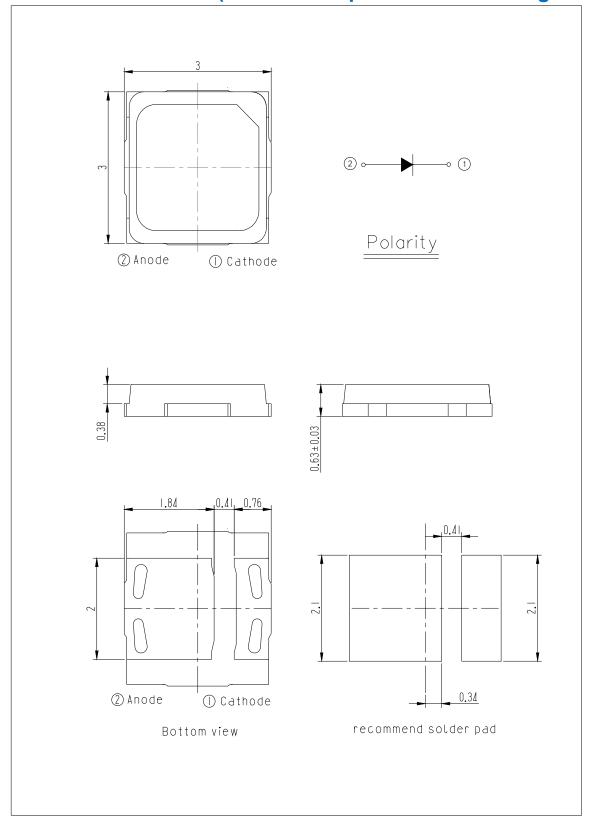
Mechanical Dimension (Green)



- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ± 0.2mm.
- 3. The thermal pad is electrically unity from the Cathode and contact pads.
- 4. Do not handle the device by the lens. Incorrect force applied to the lens may lead to the failure of devices.



Mechanical Dimension (Far Red/Deep Red/Amber/Orange/Red)

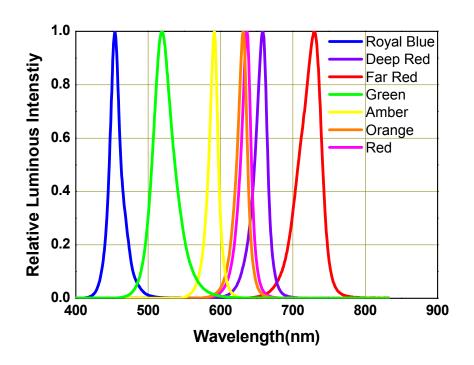


- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ± 0.2mm.
- 3. The thermal pad is electrically unity from the Anode and contact pads.
- 4. Do not handle the device by the lens. Incorrect force applied to the lens may lead to the failure of devices.

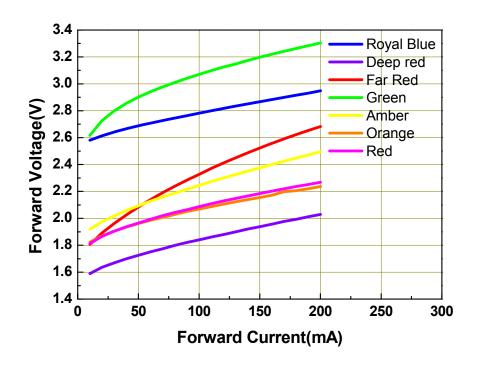
Wavelength Characteristics

Relative Spectral Distribution

@ Solder Pad Temperature = 25℃

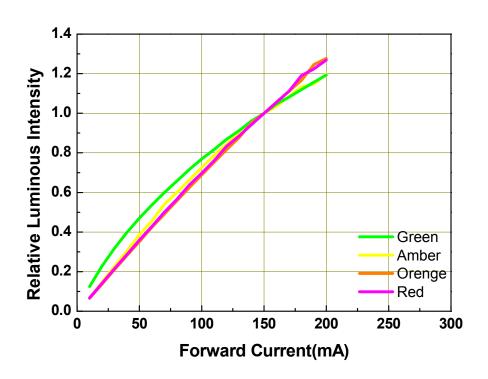


Forward Voltage vs. Forward Current @ Solder Pad Temperature = 25°C

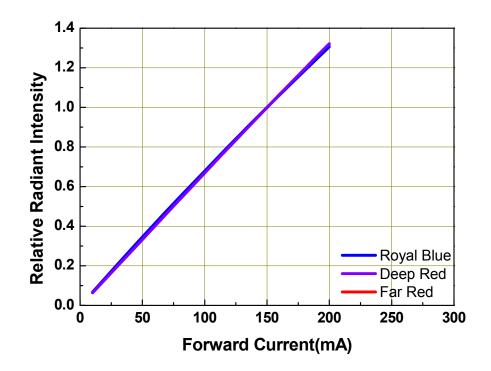




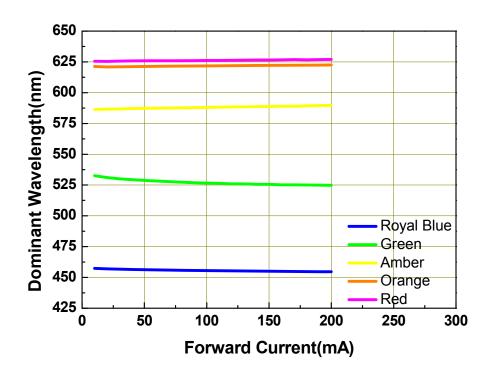
Relative Luminous Intensity vs. Forward Current @ Solder Pad Temperature = 25℃



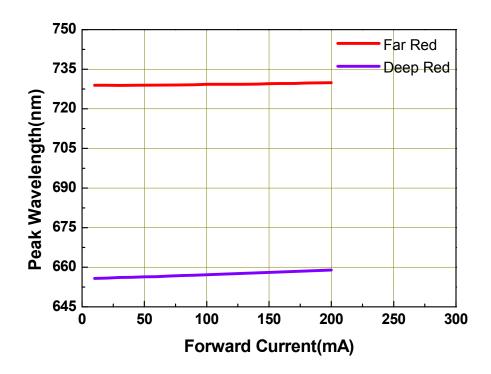
Relative Radiant Intensity vs. Forward Current @ Solder Pad Temperature = 25°C



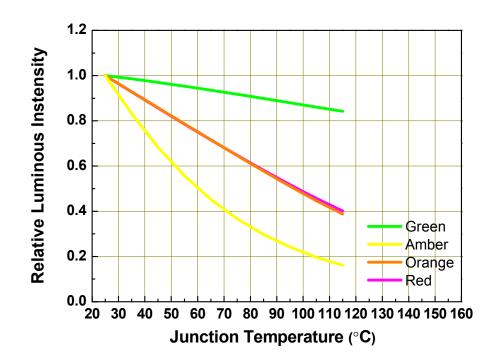
Dominant Wavelength vs. Forward Current @ Solder Pad Temperature = 25°C



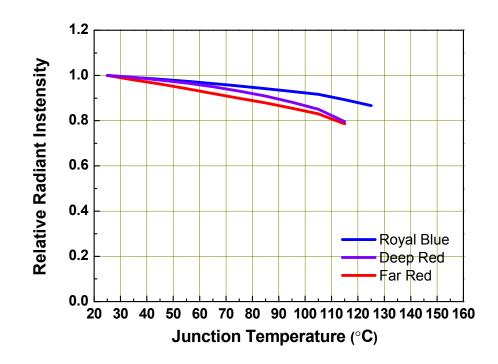
Peak Wavelength vs. Forward Current @ Solder Pad Temperature = 25°C



Relative Luminous Intensity vs. Junction Temperature @Forward Current = 150mA

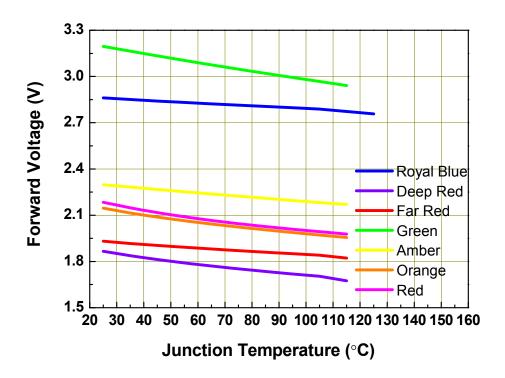


Relative Radiant Intensity vs. Junction Temperature @Forward Current = 150mA

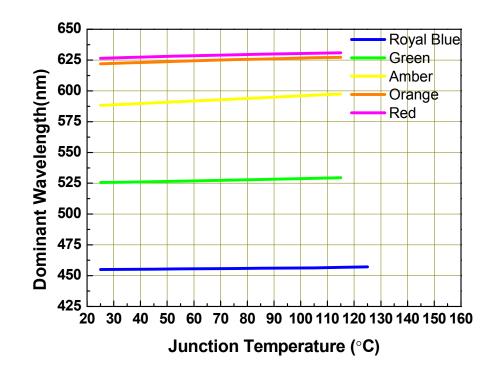




Forward Voltage vs. Junction Temperature @Forward Current = 150mA

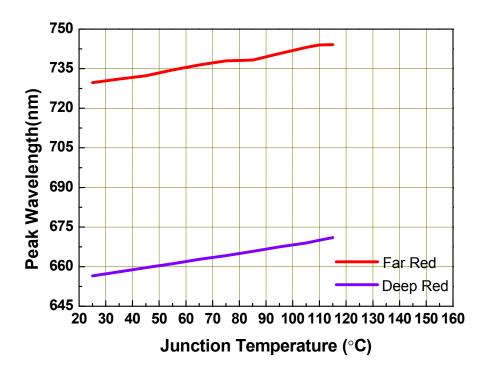


Dominant Wavelength vs. Junction Temperature @Forward Current = 150mA



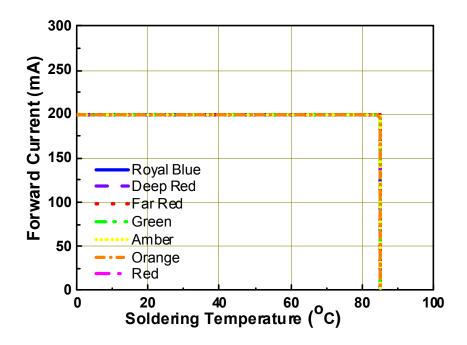


Peak Wavelength vs. Junction Temperature @Forward Current = 150mA



Forward Current Derating Curve

@ Junction Temperature <125/115°C_{III}

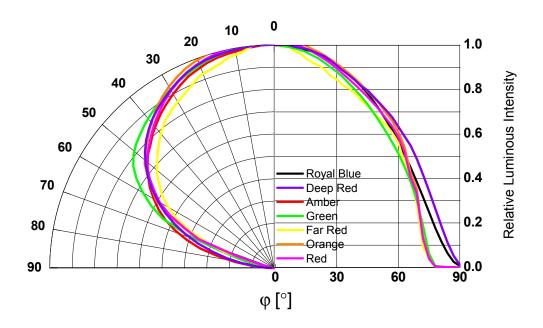


Notes:

1. For Far/Deep Red/Green/Amber/Orange/Red, the max. junction temperature=115°C. For Royal Blue, the max. junction temperature=125°C.



Typical Radiation Patterns Typical Diagram Characteristics of Radiation

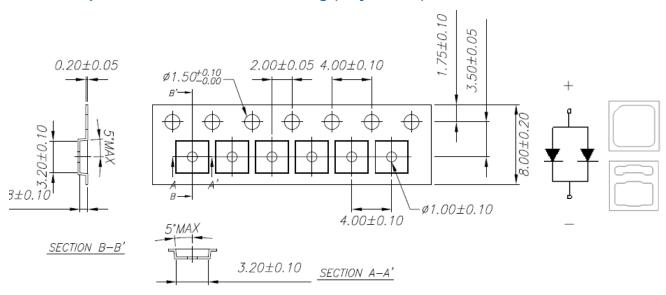


- 1. $2\theta_{1/2}$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is $\pm 5^{\circ}$.

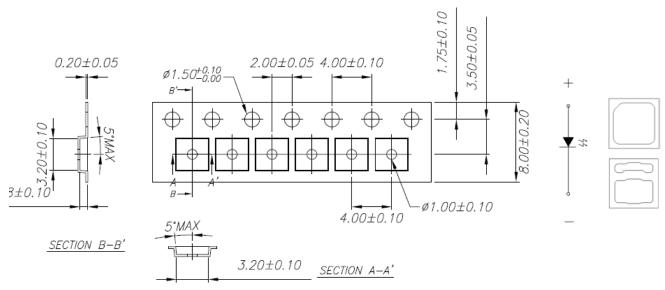


Emitter Tape Packaging

Carrier Tape Dimensions as the following (Royal Blue):



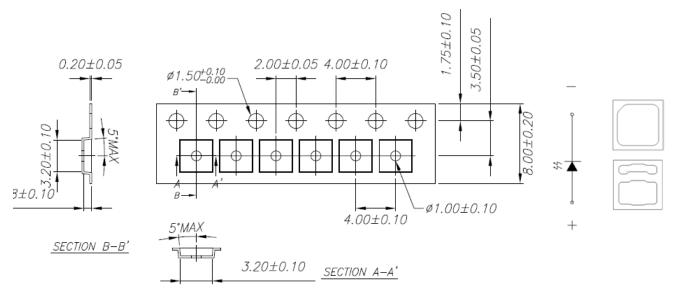
Carrier Tape Dimensions as the following (Green):



- 1.Tolerance unless mentioned is ±0.1mm; Unit = mm
- 2.Minimum packing amount is 250/500/1000/2000 pcs per reel



Carrier Tape Dimensions as the following (Far Red/Deep Red/Amber/Orange/Red):

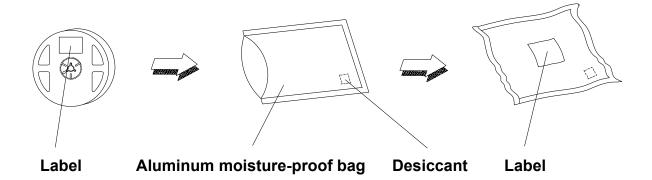


Notes:

- 1.Tolerance unless mentioned is ±0.1mm; Unit = mm
- 2.Minimum packing amount is 250/500/1000/2000 pcs per reel

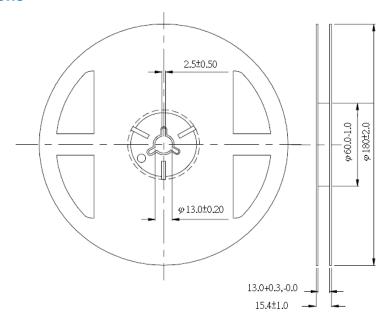
Emitter Reel Packaging

Moisture Resistant Packaging





Reel Dimensions



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ±0.1mm.

Product Labeling

Label Explanation

CPN: Customer Specification (when required)

P/N : Everlight Production Number

QTY: Packing Quantity

CAT: Luminous Flux (Brightness) Bin

HUE: Color Bin

REF: Forward Voltage Bin

LOT No: Lot Number

MADE IN TAIWAN: Production Place





Precautions for Use

1. Over-current-proof

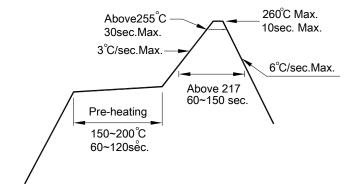
Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Assemblies

Do not stack assemblies containing Everlight XI3030 LEDs to prevent damage to the optical surface of LEDs. Forces applied to the optical surface may result in the surface being damaged.

3. Soldering Condition

3.1 Pb-free solder temperature profile



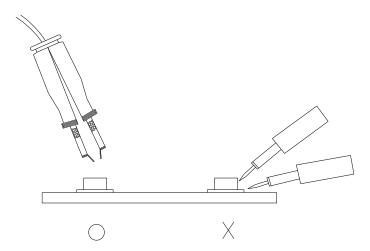
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Storage Conditions

- Before the package is opened. The LEDs should be stored at 30°C or less and 90%RH or less after being shipped from EVERLIGHT and the storage life limits are 12 months.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

DISCLAIMER

- EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized EVERLIGHT sales agent for special application request.



Revision History

Current version: 03.09.2017 Issue No: DHE-0003239

Version:2

Created by: Corrine Lu

Page	Subjects (major change in previous version)	Date of change
	Modified Royal blue's bin	03/09/2017